

# XP161A1355PR



## Power MOS FET

- ◆N-Channel Power MOS FET
- ◆DMOS Structure
- ◆Low On-State Resistance :  $0.05\Omega$  (max)
- ◆Ultra High-Speed Switching
- ◆SOT-89 Package
- ◆Gate Protect Diode Built-in

### General Description

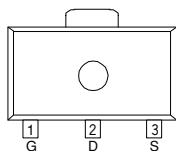
The XP161A1355PR is an N-Channel Power MOS FET with low on-state resistance and ultra high-speed switching characteristics.

Because high-speed switching is possible, the IC can be efficiently set thereby saving energy.

A gate protect diode is built-in to prevent static damage.

The small SOT-89 package makes high density mounting possible.

### Pin Configuration



SOT-89  
(TOP VIEW)

### Applications

- Notebook PCs
- Cellular and portable phones
- On-board power supplies
- Li-ion battery systems

### Features

**Low on-state resistance:**  $R_{ds(on)} = 0.05\Omega$  ( $V_{gs} = 4.5V$ )  
 $R_{ds(on)} = 0.07\Omega$  ( $V_{gs} = 2.5V$ )  
 $R_{ds(on)} = 0.15\Omega$  ( $V_{gs} = 1.5V$ )

**Ultra high-speed switching**

**Gate protect diode built-in**

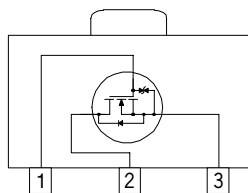
**Operational Voltage** : 1.5V

**High density mounting** : SOT-89

### Pin Assignment

PIN NUMBER	PIN NAME	FUNCTION
1	G	Gate
2	D	Drain
3	S	Source

### Equivalent Circuit



N-Channel MOS FET  
( 1 device built-in )

### Absolute Maximum Ratings

PARAMETER	SYMBOL	Ta=25°C	
		RATINGS	UNITS
Drain - Source Voltage	Vdss	20	V
Gate - Source Voltage	Vgss	± 8	V
Drain Current (DC)	Id	4	A
Drain Current (Pulse)	Idp	16	A
Reverse Drain Current	Idr	4	A
Continuous Channel Power Dissipation (note)	Pd	2	W
Channel Temperature	Tch	150	°C
Storage Temperature	Tstg	- 55 ~ 150	°C

( note ) : When implemented on a ceramic PCB

## Electrical Characteristics

### DC Characteristics

Ta=25°C

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Drain Cut-off Current	I <sub>dss</sub>	V <sub>ds</sub> = 20V , V <sub>gs</sub> = 0V			10	μA
Gate-Source Leakage Current	I <sub>gss</sub>	V <sub>gs</sub> = ± 8V , V <sub>ds</sub> = 0V			± 10	μA
Gate-Source Cut-off Voltage	V <sub>gs (off)</sub>	I <sub>d</sub> = 1mA , V <sub>ds</sub> = 10V	0.5		1.2	V
Drain-Source On-state Resistance ( note )	R <sub>ds ( on )</sub>	I <sub>d</sub> = 2A , V <sub>gs</sub> = 4.5V		0.37	0.05	Ω
		I <sub>d</sub> = 2A , V <sub>gs</sub> = 2.5V		0.05	0.07	Ω
		I <sub>d</sub> = 0.5A , V <sub>gs</sub> = 1.5V		0.1	0.15	Ω
Forward Transfer Admittance ( note )	Y <sub>fs</sub>	I <sub>d</sub> = 2A , V <sub>ds</sub> = 10V		10		S
Body Drain Diode Forward Voltage	V <sub>f</sub>	I <sub>f</sub> = 4A , V <sub>gs</sub> = 0V		0.85	1.1	V

( note ) : Effective during pulse test.

### Dynamic Characteristics

Ta=25°C

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Input Capacitance	C <sub>iss</sub>	V <sub>ds</sub> = 10V , V <sub>gs</sub> = 0V f = 1 MHz		390		pF
Output Capacitance	C <sub>oss</sub>			210		pF
Feedback Capacitance	C <sub>rss</sub>			90		pF

### Switching Characteristics

Ta=25°C

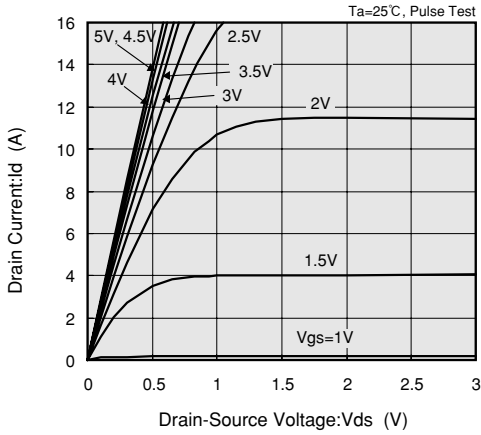
PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Turn-on Delay Time	t <sub>d ( on )</sub>	V <sub>gs</sub> = 5V , I <sub>d</sub> = 2A V <sub>dd</sub> = 10V		10		ns
Rise Time	t <sub>r</sub>			15		ns
Turn-off Delay Time	t <sub>d ( off )</sub>			85		ns
Fall Time	t <sub>f</sub>			45		ns

### Thermal Characteristics

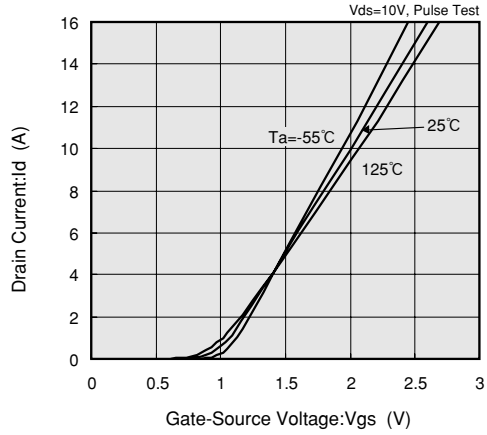
PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Thermal Resistance ( channel-ambience )	R <sub>th ( ch-a )</sub>	Implement on a ceramic PCB		62.5		°C / W

## Typical Performance Characteristics

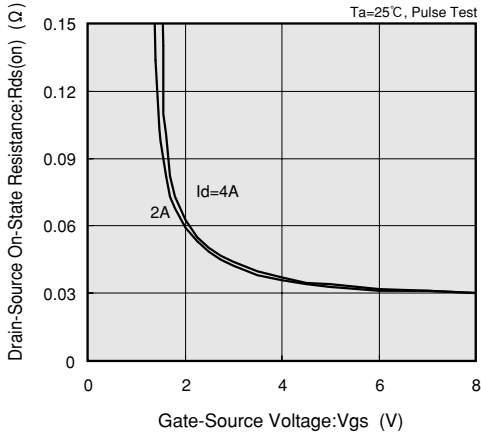
DRAIN CURRENT vs. DRAIN-SOURCE VOLTAGE



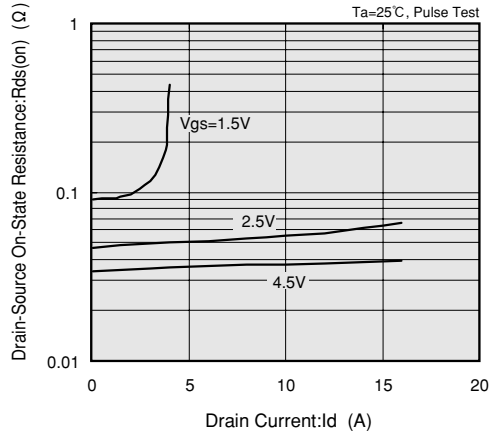
DRAIN CURRENT vs. GATE-SOURCE VOLTAGE



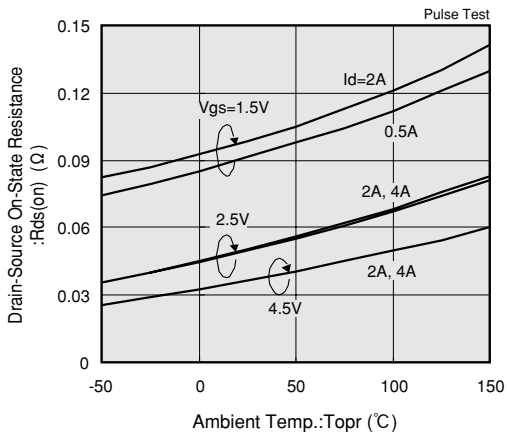
DRAIN-SOURCE ON-STATE RESISTANCE vs. GATE-SOURCE VOLTAGE



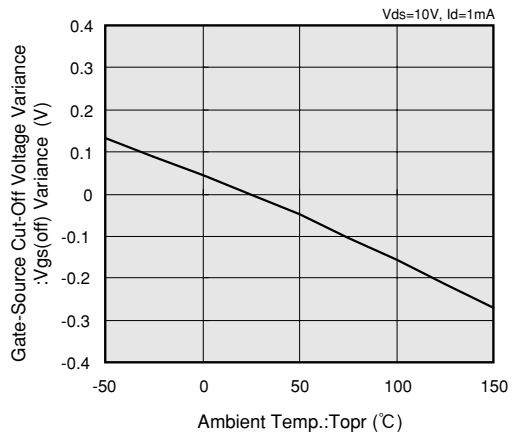
DRAIN-SOURCE ON-STATE RESISTANCE vs. DRAIN CURRENT



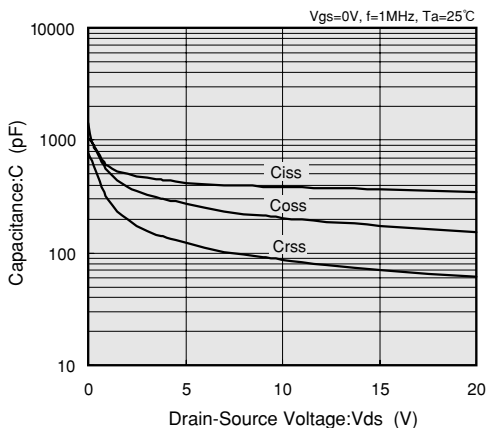
DRAIN-SOURCE ON-STATE RESISTANCE vs. AMBIENT TEMPERATURE



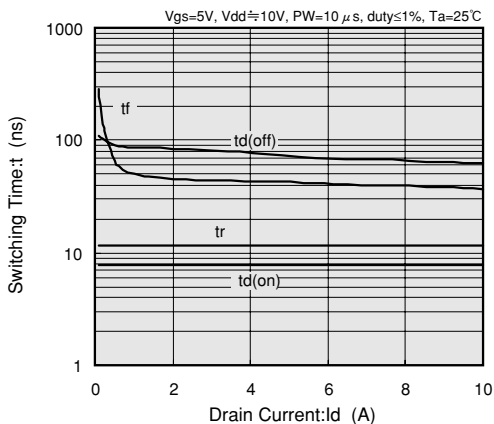
GATE-SOURCE CUT-OFF VOLTAGE VARIANCE vs. AMBIENT TEMPERATURE



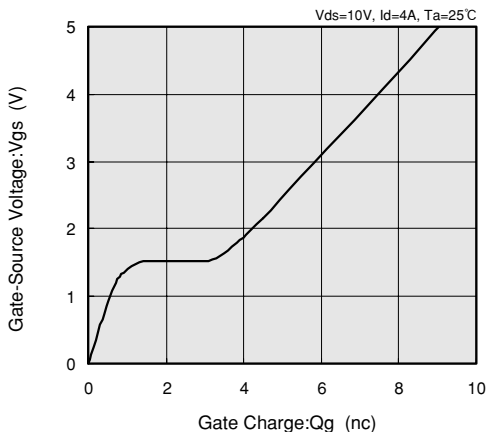
CAPACITANCE vs. DRAIN-SOURCE VOLTAGE



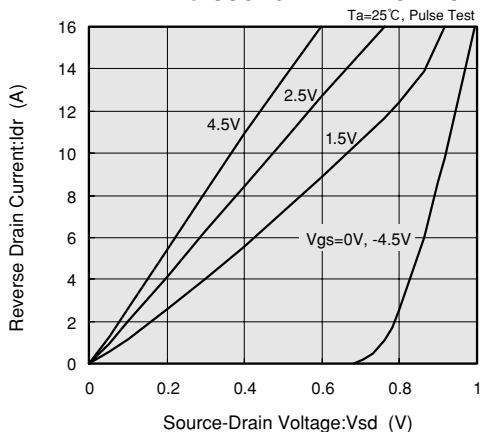
SWITCHING TIME vs. DRAIN CURRENT



GATE-SOURCE VOLTAGE vs. GATE CHARGE



REVERSE DRAIN CURRENT vs. SOURCE-DRAIN VOLTAGE



STANDARDIZED TRANSITION THERMAL RESISTANCE vs. PULSE WIDTH

